

Dual LDO Regulators, Low ESR Cap. Compatible

■ GENERAL DESCRIPTION

The XC6401 series are highly accurate, Dual, low noise, CMOS LDO voltage regulators. Performance features of the series includes low output noise, high ripple rejection ratio, low dropout and very fast turn-on times.

The XC6401 includes a reference voltage source, error amplifiers, driver transistors, current limiters and phase compensators internally. The XC6401's current limiters' foldback circuit also operates as a short protect for the output current limiter. The output voltage for each regulator is set independently by laser trimming. Voltages are selectable in 0.05V steps within a range of 0.8V to 5.0V. The XC6401 series is also fully compatible with low ESR ceramic capacitors, reducing cost and improving output stability.

This high level of output stability is maintained even during frequent load fluctuations, due to the excellent transient response performance and high PSRR achieved across a broad range of frequencies. The EN function allows the output of each regulator to be turned off independently, resulting in greatly reduced power consumption. The XC6401 series is available in the SOT-26W or USP-6B, USP-6C 'chip-scale' package.

■ APPLICATIONS

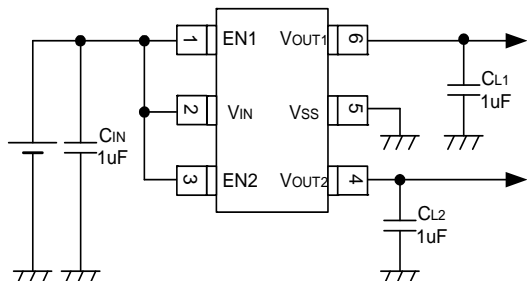
- Mobile Phones
- Cordless phones and radio communication equipment
- Portable games
- Cameras, Video recorders
- Portable Audio Equipment
- PDAs

■ FEATURES

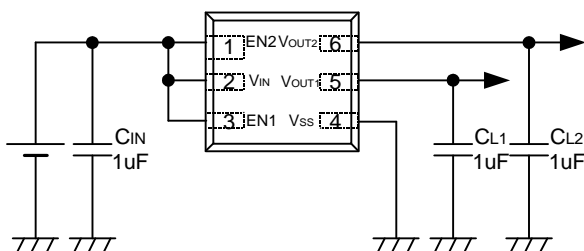
Maximum Output Current	: More than 150mA (300mA limit)
Dropout Voltage	: 100mV @100mA
Operating Voltage Range	: 1.5V ~ 6.0V
Output Voltage Range	: 0.8V~5.0V (0.05V increments)
Highly Accurate	: $\pm 2\%$ ($V_{OUT} > 1.5V$)
	: $\pm 30mV$ ($V_{OUT} \leq 1.5V$)
Low Power Consumption	: 25 μA (TYP.)
Standby Current	: Less than 0.1 μA (TYP.)
High Ripple Rejection	: 70dB @1kHz
Operating Temperature Range	: -40°C ~ +85°C
Low ESR Capacitor Compatible	: Ceramic capacitor
Low Output Noise	
Packages	: SOT-26W, USP-6B, USP-6C
Environmentally Friendly	: EU RoHS Compliant, Pb Free

■ TYPICAL APPLICATION CIRCUITS

● SOT-26W



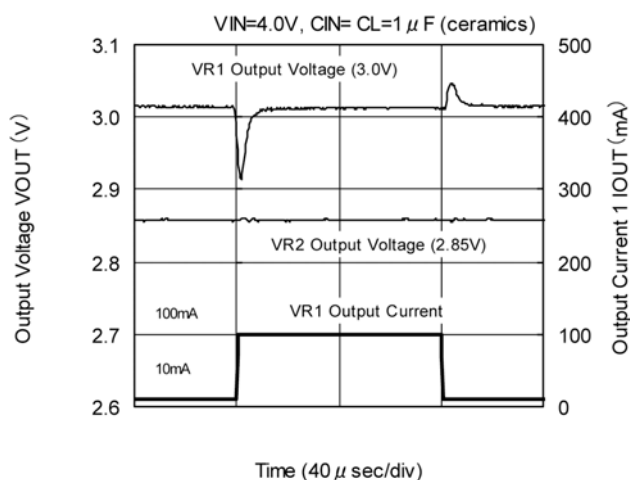
● USP-6



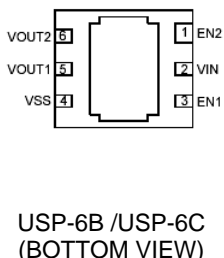
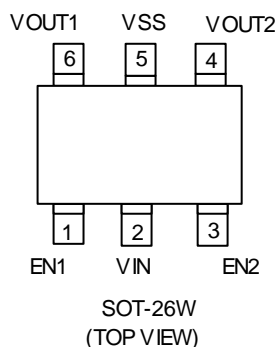
■ TYPICAL PERFORMANCE CHARACTERISTICS

● Interactive Load Transient Response

XC6401 (VR1:3.0V, VR2:2.85V)



PIN CONFIGURATION



*The dissipation pad for the USP-6B/C packages should be solder-plated in recommended mount pattern and metal masking so as to enhance mounting strength and heat release.
If the pad needs to be connected to other pins, it should be connected to the Vss pin.

PIN ASSIGNMENT

PIN NUMBER		PIN NAME	FUNCTION
SOT-26W	USP-6B/C		
1	3	EN1	ON/OFF Control 1
2	2	VIN	Power Input
3	1	EN2	ON/OFF Control 2
4	6	VOUT2	Output 2
5	4	VSS	Ground
6	5	VOUT1	Output 1

PRODUCT CLASSIFICATION

● Selection Guide

The following options for the Regulator 1, 2, the EN pin logic, internal pull-up / down are available.

● Ordering Information

XC6401①②③④⑤⑥-⑦^(*)

DESIGNATOR	DESCRIPTION	SYMBOL	DESCRIPTION
①	Regulator1, EN type	E	High Active with pull-down resistor
		F	High Active with no pull-down resistor
		G	Low Active with pull-up resistor
		H	Low Active with no pull-up resistor
②	Regulator2, EN type	E	High Active with pull-down resistor
		F	High Active with no pull-down resistor
		G	Low Active with pull-up resistor
		H	Low Active with no pull-up resistor
③④	Output Voltage	01~	Internally set sequential number relating output voltage of each regulators Regulator 1 Output Voltage Range: 0.8 ~ 5.0 V (0.05V increments) Regulator 2 Output Voltage Range: 0.8 ~ 5.0 V (0.05V increments)
⑤⑥-⑦	Packages Taping Type ^(*)	MR	SOT-26W
		MR-G	SOT-26W
		DR	USP-6B
		DR-G	USP-6B
		ER	USP-6C
		ER-G	USP-6C

^(*) The "-G" suffix indicates that the products are Halogen and Antimony free as well as being fully RoHS compliant.

^(*) The device orientation is fixed in its embossed tape pocket.

For reverse orientation, please contact your local Torex sales office or representative.

(Standard orientation: ⑤R-⑦, Reverse orientation: ⑤L-⑦)

■ ABSOLUTE MAXIMUM RATINGS

Ta = 25°C

PARAMETER		SYMBOL	RATINGS	UNITS
Input Voltage		V _{IN}	6.5	V
Output Current		I _{OUT1} + I _{OUT2}	700	mA
Output Voltage		V _{OUT}	V _{SS} -0.3 ~ V _{IN} +0.3	V
EN Pin Voltage		V _{EN}	V _{SS} -0.3 ~ 6.5	V
Power Dissipation	SOT-26W	P _d	250	mW
	USP-6B		100	
	USP-6C		100	
Operating Temperature Range		T _{opr}	-40 ~ +85	°C
Storage Temperature Range		T _{stg}	-55 ~ +125	°C

* Sum of I_{OUT1} and I_{OUT2}.

** P_d=(V_{IN}-V_{OUT1})×I_{OUT1}+(V_{IN}-V_{OUT2})×I_{OUT2}

■ ELECTRICAL CHARACTERISTICS

XC6401FFxx

Regulator 1, Regulator 2

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage (*3)	V _{OUT} (E)	V _{IN} =V _{OUT} (T) + 1.0V I _{OUT} =30mA	0.98	V _{OUT} (T)	1.02	V	1
Maximum Output Current	I _{OUTMAX}	V _{IN} =V _{OUT} (T) + 1.0V	150	-	-	mA	1
Load Regulation	ΔV _{OUT}	1mA ≤ I _{OUT} ≤ 100mA	-	15	60	mV	1
Dropout Voltage	V _{dif1}	I _{OUT} =30mA	E-1			mV	1
	V _{dif2}	I _{OUT} =100mA	E-2			mV	
Supply Current	I _{SS}	V _{IN} =V _{EN} =V _{OUT} (T) + 1.0V, I _{OUT} =0mA	-	25	45	μA	2
Standby Current	I _{STB}	V _{IN} =V _{OUT} (T) + 1.0V, V _{EN} =V _{SS}	-	0.01	0.10	μA	3
Line Regulation (*7)	$\frac{\Delta V_{OUT}}{\Delta V_{IN} \cdot V_{OUT}}$	V _{OUT} (T)+1.0V ≤ V _{IN} ≤ 6.0V V _{EN} =V _{IN} , I _{OUT} =30mA	-	0.01	0.20	% / V	1
Input Voltage	V _{IN}		1.5	-	6.0	V	-
Output Voltage Temperature Characteristics	$\frac{\Delta V_{OUT}}{\Delta T_{opr} \cdot V_{OUT}}$	I _{OUT} =30mA -40°C ≤ T _{opr} ≤ 85°C	-	±100	-	ppm/°C	1
Ripple Rejection Rate(*8)	PSRR	V _{IN} =[V _{OUT} (T)+1.0]V _{DC} +0.5V _{p-pAC} I _{OUT} =30mA, f=1kHz	-	70	-	dB	5
Current Limiter	I _{lim}	V _{IN} =V _{OUT} (T) + 1.0V, V _{EN} =V _{IN}	-	300	-	mA	1
Short-Circuit Current	I _{short}	V _{IN} =V _{OUT} (T) + 1.0V, V _{EN} =V _{IN}	-	30	-	mA	1
EN "High" Voltage	V _{ENH}		1.30	-	6.0	V	4
EN "Low" Voltage	V _{ENL}		-	-	0.25	V	4
EN "High" Current	I _{ENH}	V _{IN} =V _{EN} =V _{OUT} (T) + 1.0V	-0.10	-	0.10	μA	4
EN "Low" Current	I _{ENL}	V _{IN} =V _{OUT} (T) + 1.0V, V _{EN} =V _{SS}	-0.10	-	0.10	μA	4

NOTE *1: V_{OUT}(T)=Specified output voltage

*2: V_{OUT}(E)=Effective output voltage

(I.e. the output voltage when "V_{OUT}(T) + 1.0V" is provided at the V_{IN} pin while maintaining a certain I_{OUT} value).

*3: If V_{OUT} (T) ≤ 1.45V, MIN V_{OUT} (T) - 30mV, MAX V_{OUT} (T) + 30mV

*4: V_{dif}={V_{IN1}⁽⁶⁾-V_{OUT1}^{(5)}}

*5: V_{OUT1}=A voltage equal to 98% of the output voltage whenever an amply stabilized I_{OUT} {V_{OUT}(T)+1.0V} is input.

*6: V_{IN1}=the input voltage when V_{OUT1} appears as input voltage is gradually decreased.

*7: When V_{OUT}(T) ≥ 4.5V, 5.5V ≤ V_{IN} ≤ 6.0V

*8: When V_{OUT}(T) ≥ 4.8V, V_{IN}=5.75V_{DC}+0.5V_{p-pAC}

*9: Unless otherwise stated, V_{IN}=V_{OUT}(T)+1.0V

■ ELECTRICAL CHARACTERISTICS (Continued)

● Dropout Voltage

SETTING OUTPUT VOLTAGE	DETECT VOLTAGE		E-1		E-2	
			DROPOUT VOLTAGE 1		DROPOUT VOLTAGE 2	
	(V)		(mV)		(mV)	
(V)	V _{OUT}		V _{dif} 1		V _{dif} 2	
V _{OUT(T)}	MIN.	MAX.	TYP.	MAX.	TYP.	MAX.
0.80	0.770	0.830	300	700	400	800
0.85	0.820	0.880				
0.90	0.870	0.930				
0.95	0.920	0.980	200	600	350	700
1.00	0.970	1.030				
1.05	1.020	1.080				
1.10	1.070	1.130	100	500	270	600
1.15	1.120	1.180				
1.20	1.170	1.230				
1.25	1.220	1.280	80	400	240	500
1.30	1.270	1.330				
1.35	1.320	1.380				
1.40	1.370	1.430	65	300	200	400
1.45	1.420	1.480				
1.50	1.470	1.530				
1.55	1.519	1.581	60	200	180	300
1.60	1.568	1.632				
1.65	1.617	1.683				
1.70	1.666	1.734	55	100	165	250
1.75	1.715	1.785				
1.80	1.764	1.836				
1.85	1.813	1.887	50	75	150	200
1.90	1.862	1.938				
1.95	1.911	1.989				
2.00	1.960	2.040	45	65	140	180
2.05	2.009	2.091				
2.10	2.058	2.142				
2.15	2.107	2.193	40	60	120	170
2.20	2.156	2.244				
2.25	2.205	2.295				
2.30	2.254	2.346	35	55	110	160
2.35	2.303	2.397				
2.40	2.352	2.448				
2.45	2.401	2.499	30	50	100	150
2.50	2.450	2.550				
2.55	2.499	2.601				
2.60	2.548	2.652	25	45	90	140
2.65	2.597	2.703				
2.70	2.646	2.754				
2.75	2.695	2.805	20	40	80	130
2.80	2.744	2.856				
2.85	2.793	2.907				
2.90	2.842	2.958	15	35	70	120
2.95	2.891	3.009				

■ DROPOUT VOLTAGE CHART (Continued)

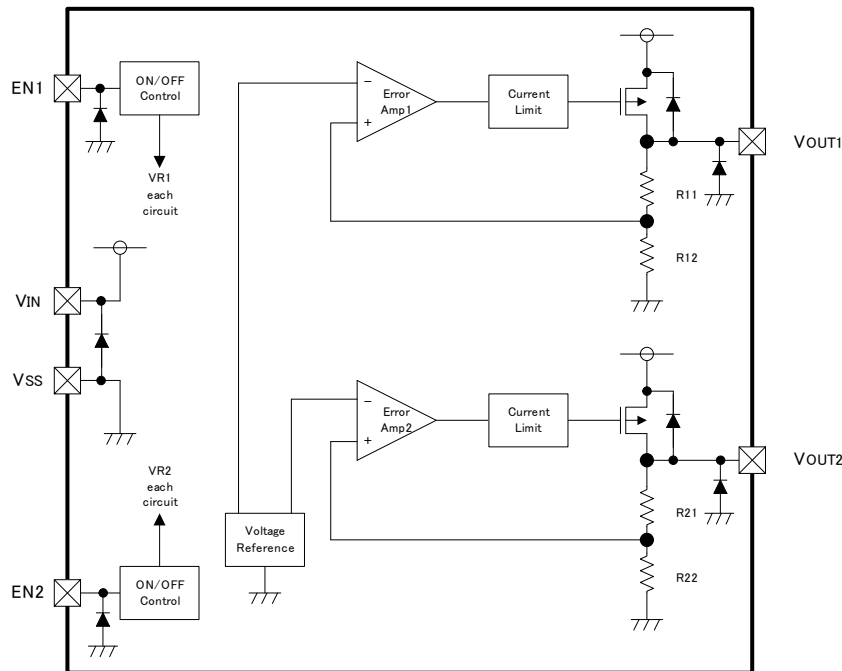
● Dropout Voltage (Continued)

SETTING OUTPUT VOLTAGE	DETECT VOLTAGE		E-1		E-2	
			DROPOUT VOLTAGE 1		DROPOUT VOLTAGE 2	
	(V)		(mV)		(mV)	
(V)	V _{OUT}		V _{dif} 1		V _{dif} 2	
V _{OUT(T)}	MIN.	MAX.	TYP.	MAX.	TYP.	MAX.
3.00	2.940	3.060	30	45	100	150
3.05	2.989	3.111				
3.10	3.038	3.162				
3.15	3.087	3.213				
3.20	3.136	3.264				
3.25	3.185	3.315				
3.30	3.234	3.366				
3.35	3.283	3.417				
3.40	3.332	3.468				
3.45	3.381	3.519				
3.50	3.430	3.570				
3.55	3.479	3.621				
3.60	3.528	3.672				
3.65	3.577	3.723				
3.70	3.626	3.774				
3.75	3.675	3.825				
3.80	3.724	3.876				
3.85	3.773	3.927				
3.90	3.822	3.978				
3.95	3.871	4.029				
4.00	3.920	4.080				
4.05	3.969	4.131				
4.10	4.018	4.182				
4.15	4.067	4.233				
4.20	4.116	4.284				
4.25	4.165	4.335				
4.30	4.214	4.386				
4.35	4.263	4.437				
4.40	4.312	4.488				
4.45	4.361	4.539				
4.50	4.410	4.590				
4.55	4.459	4.641				
4.60	4.508	4.692				
4.65	4.557	4.743				
4.70	4.606	4.794				
4.75	4.655	4.845				
4.80	4.704	4.896				
4.85	4.753	4.947				
4.90	4.802	4.998				
4.95	4.851	5.049				
5.00	4.900	5.100				

OPERATIONAL EXPLANATION

<Output Voltage Control>

The voltage divided by resistors R1 & R2 is compared with the internal reference voltage by the error amplifier. The P-channel MOSFETs, which are connected to the VOUT1 and VOUT2 pins, are then driven by the subsequent output signal. The output voltages at the VOUT1 and VOUT2 pins are controlled and stabilized by a system of negative feedback. The current limit circuit and short protect circuit operate in relation to the level of output current. Further, the IC's internal circuitry can be shutdown via the EN pin's signal.



<Low ESR Capacitors>

With the XC6401 series, a stable output voltage is achievable even if used with low ESR capacitors as a phase compensation circuit is built-in. In order to ensure the effectiveness of the phase compensation, we suggest that output capacitors (CL1, CL2) is connected as close as possible to the output pins (VOUT1 and VOUT2) and the VSS pin. Please use an output capacitor with a capacitance value of at least 1 μ F. Also, please connect an input capacitor (CIN) of 1 μ F between the VIN pin and the VSS pin in order to ensure a stable power input.

<Current Limiter, Short-Circuit Protection>

The XC6401 series includes a combination of a fixed current limiter circuit & a foldback circuit which aid the operations of the current limiter and circuit protection. When the load current reaches the current limit level, the fixed current limiter circuit operates and output voltage drops. As a result of this drop in output voltage, the foldback circuit operates, output voltage drops further and output current decreases. When the output pin is shorted, a current of about 30mA flows.

<EN Pins>

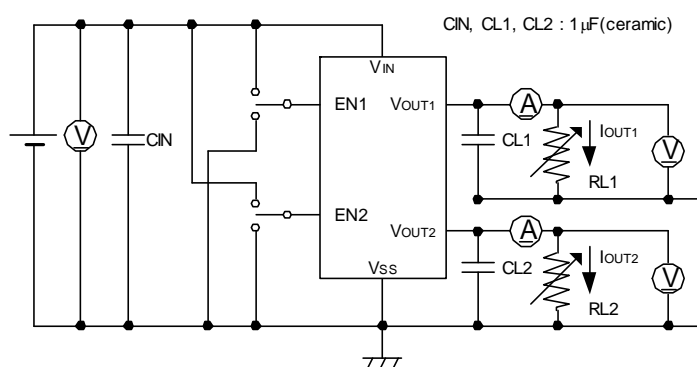
The IC's internal circuitry can be shutdown via the signal from the EN1 and EN2 pins with the XC6401 series. In shutdown mode, output at the VOUT1 and VOUT2 pins will be pulled down to the VSS level via R11 & R12 and R21 & R22. The operational logic of the IC's EN1 and EN2 pins are selectable (please refer to the selection guide). Note that as the standard XC6401FF type's regulator 1 and 2 are both 'High Active/No Pull Down', operations will become unstable with the EN1 or EN2 pins open. Although the EN1 and EN2 pins are equal to an inverter input with CMOS hysteresis, with either the pull-up or pull-down options, the EN1 and EN2 pins input current will increase when the IC is in operation. We suggest that you use this IC with either a VIN voltage or a VSS voltage input at the EN1 and EN2 pins. If this IC is used with the correct specifications for the EN1 and EN2 pins, the operational logic is fixed and the IC will operate normally. However, supply current may increase as a result of through current in the IC's internal circuitry.

NOTES ON USE

1. Please use this IC within the stated absolute maximum ratings.
The IC is liable to malfunction should the ratings be exceeded.
2. Where wiring impedance is high, operations may become unstable due to noise and/or phase lag depending on output current. Please keep the resistance low between VIN and VSS wiring in particular.
3. Please wire the input capacitor (CIN) and the output capacitors (CL1, CL2) as close to the IC as possible.

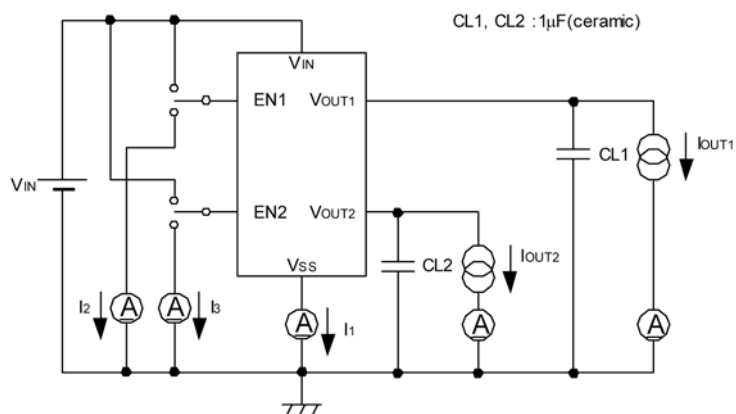
■ TEST CIRCUITS

Circuit ①



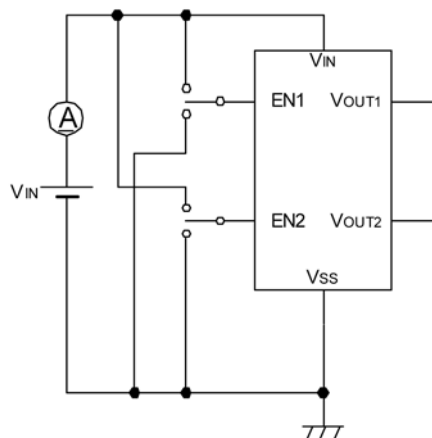
EN1/EN2 :
High Active = EN=VIN
Low Active = EN=VSS

Circuit ②



- EN1/EN2 :
- High Active with pull-down resistor built-in
VR1 Supply Current $I_{SS1}=I1$ (Note:EN1=ON, EN2=OFF)
VR2 Supply Current $I_{SS2}=I1$ (Note:EN1=OFF, EN2=ON)
 - High Active with no pull-down resistor built-in
VR1 Supply Active Current $I_{SS1}=I1$
(Note:EN1=ON, EN2=OFF)
VR2 Supply Current $I_{SS2}=I1$ (Note:EN1=OFF, EN2=ON)
 - Low Active with pull-up resistor built-in
VR1 Supply Current $I_{SS1}=I1+I2$
(Note:EN1=ON, EN2=OFF)
VR2 Supply Current $I_{SS2}=I1+I3$
(Note:EN1=OFF, EN2=ON)
 - Low Active with no pull-up resistor built-in
VR1 Supply Current $I_{SS1}=I1$ (Note:EN1=ON, EN2=OFF)
VR2 Supply Current $I_{SS2}=I1$ (Note:EN1=OFF, EN2=ON)

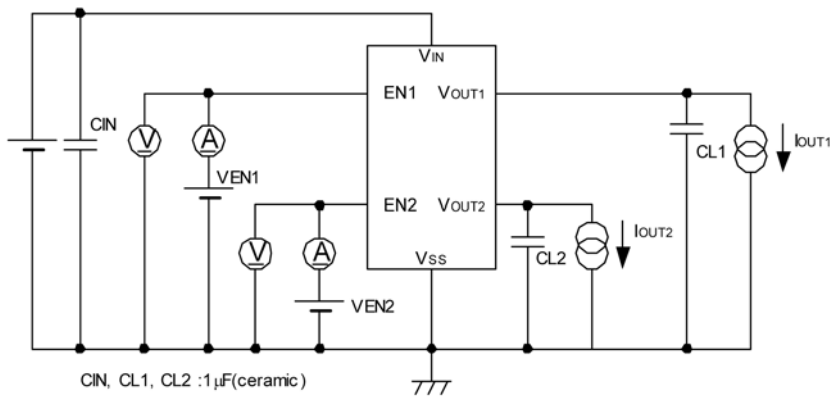
Circuit ③



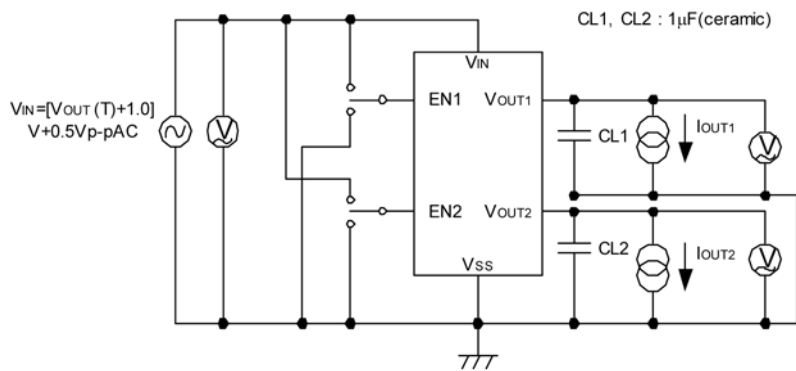
EN1/EN2:
High Active = EN= VSS
Low Active = EN= VIN

TEST CIRCUITS (Continued)

Circuit ④



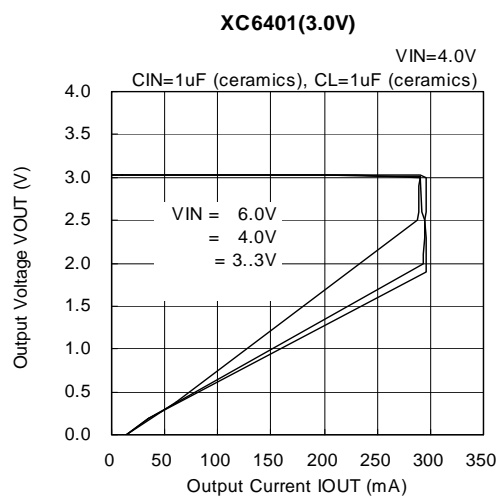
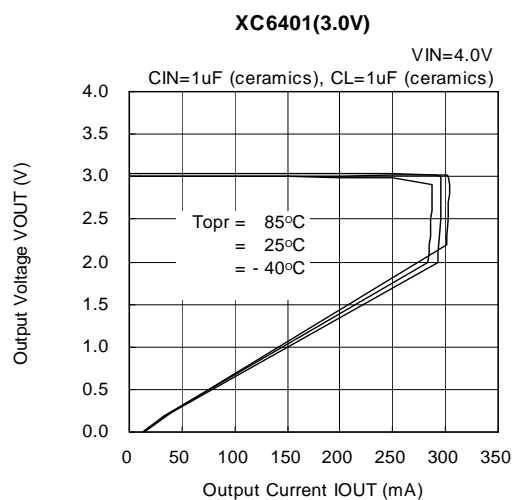
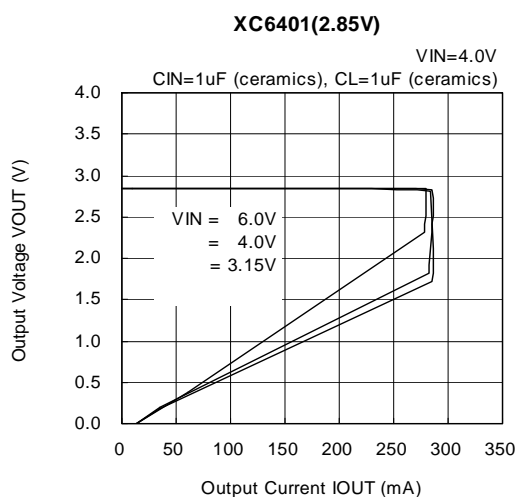
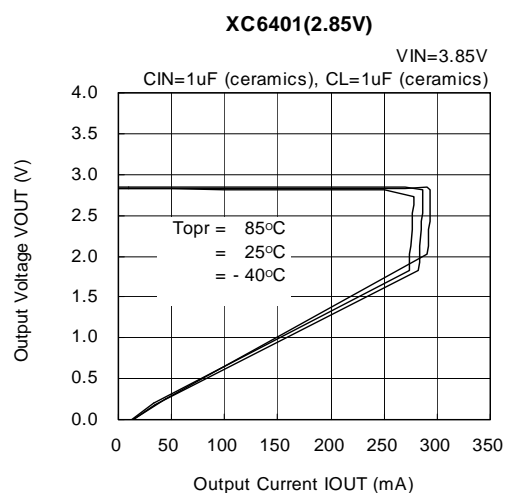
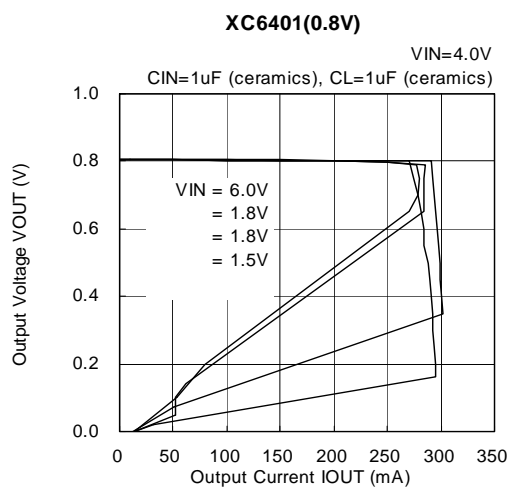
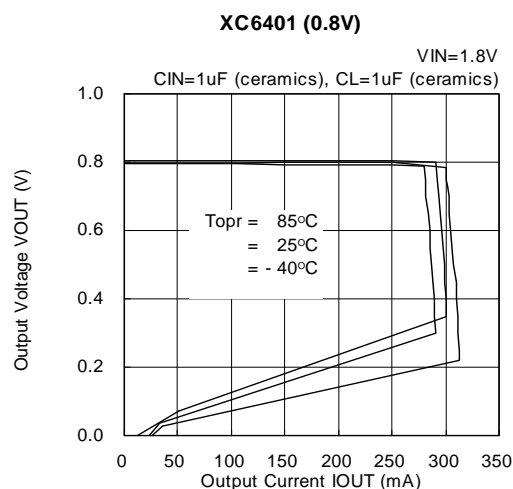
Circuit ⑤



EN1/EN2 :
High Active = EN=VIN
Low Active = EN=VSS

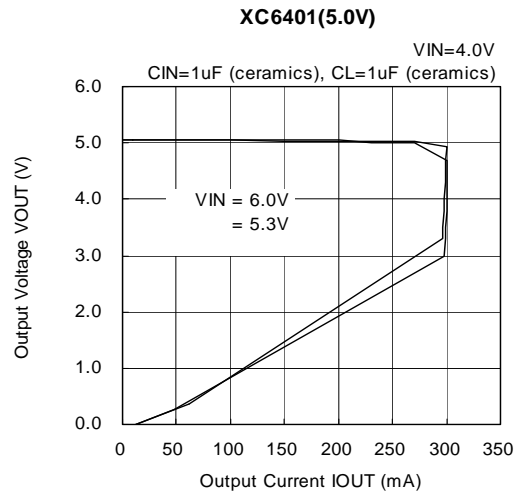
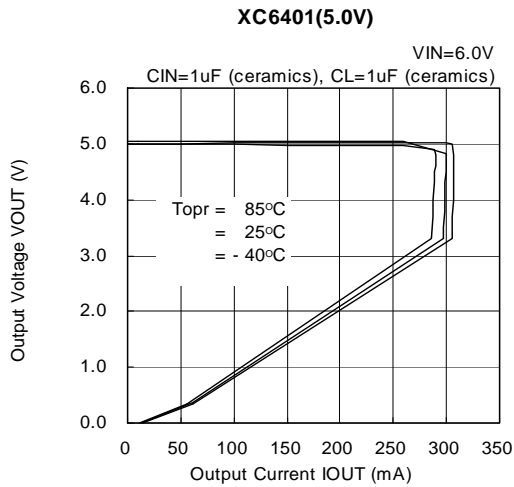
■ TYPICAL PERFORMANCE CHARACTERISTICS

(1) Output Voltage vs. Output Current

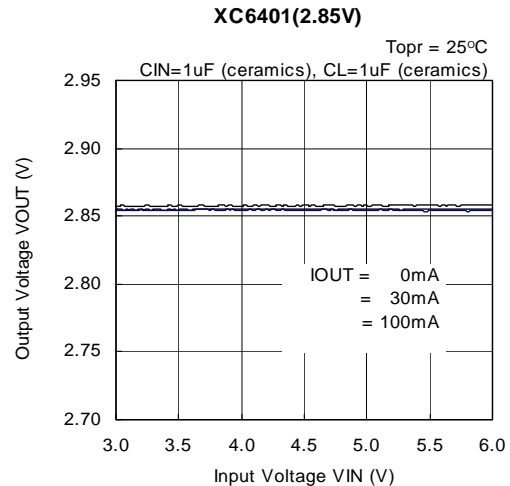
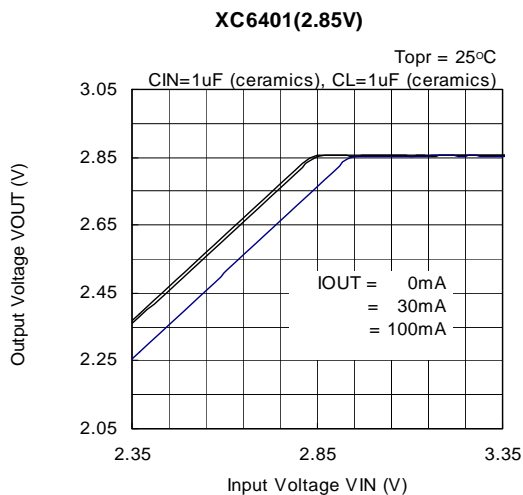
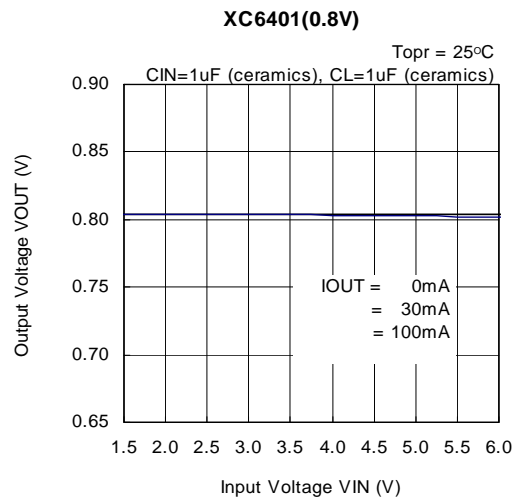
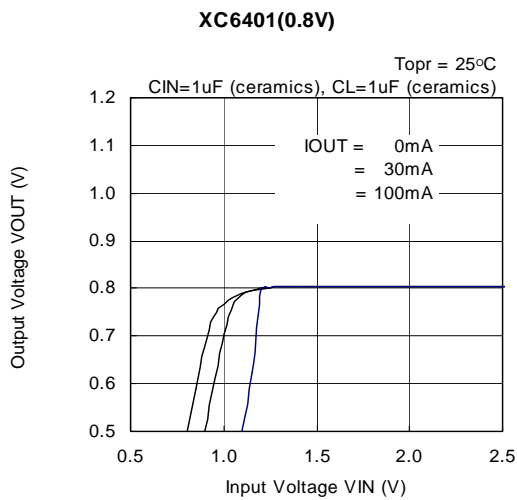


TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(1) Output Voltage vs. Output Current (Continued)

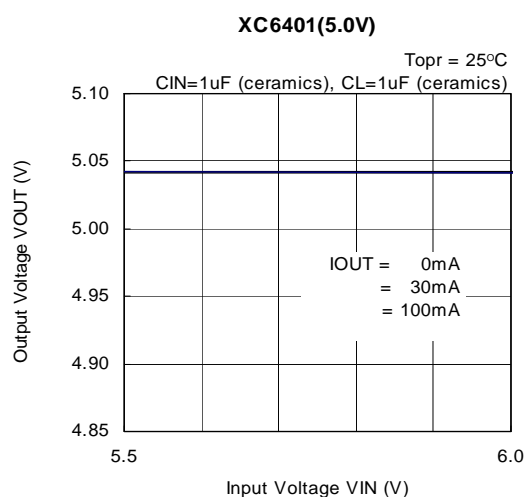
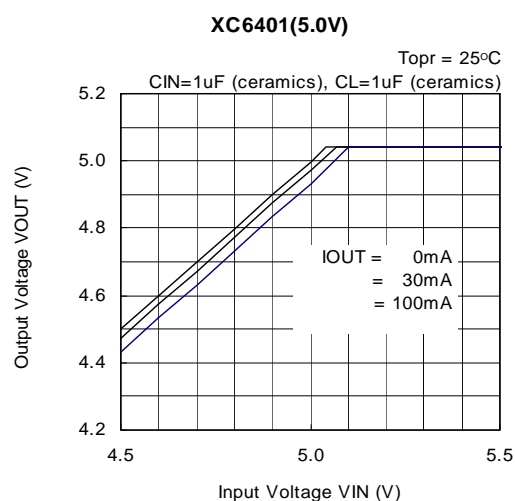
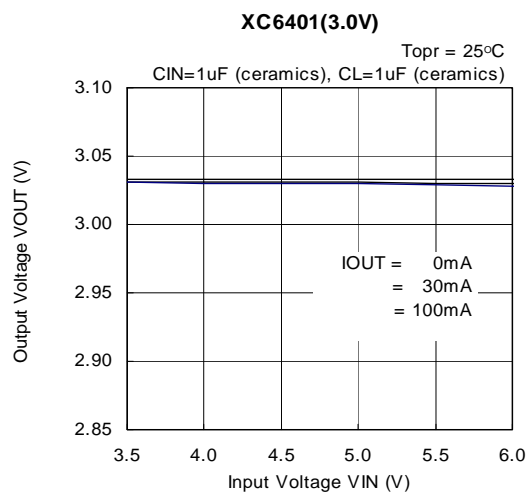
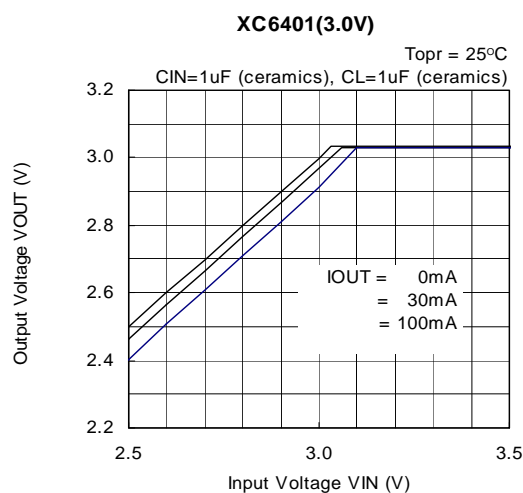


(2) Output Voltage vs. Input Voltage

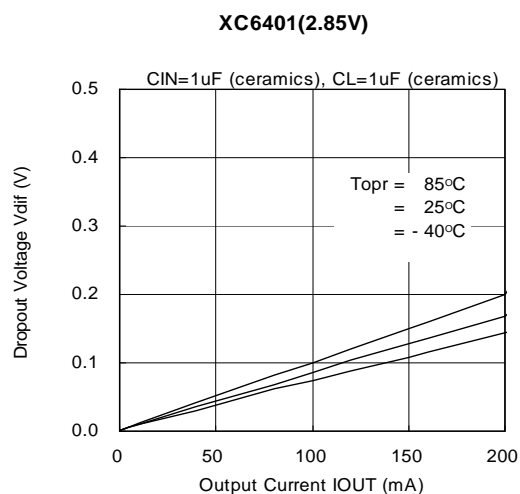
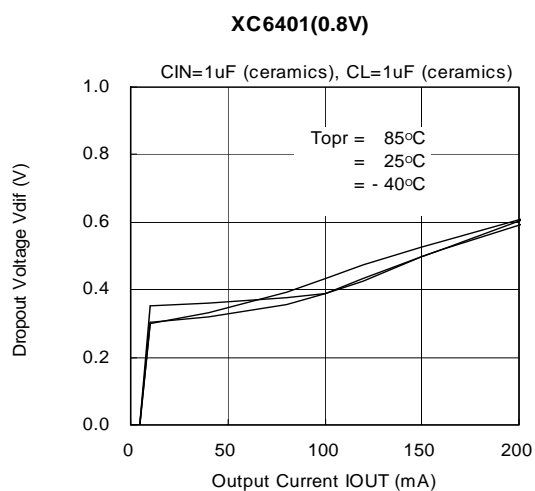


■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(2) Output Voltage vs. Input Voltage (Continued)



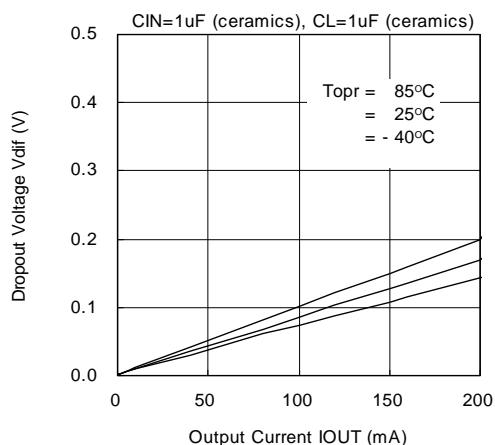
(3) Dropout Voltage vs. Output Current



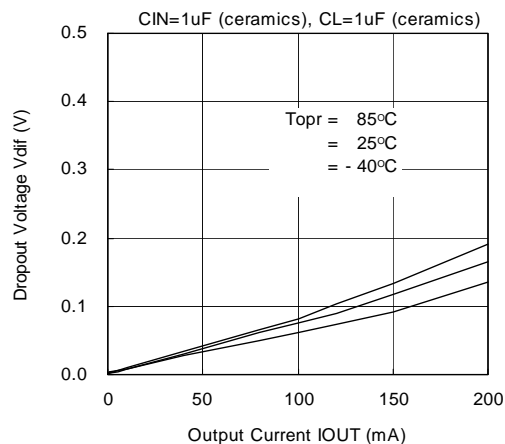
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(3) Dropout Voltage vs. Output Current (Continued)

XC6401(3.0V)

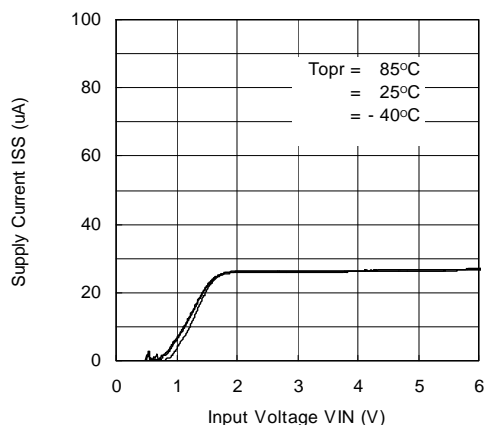


XC6401(5.0V)

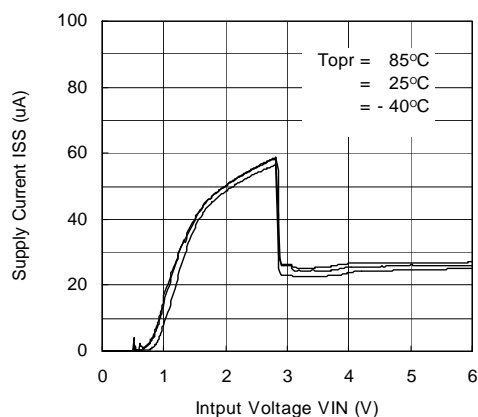


(4) Supply Current vs. Input Voltage

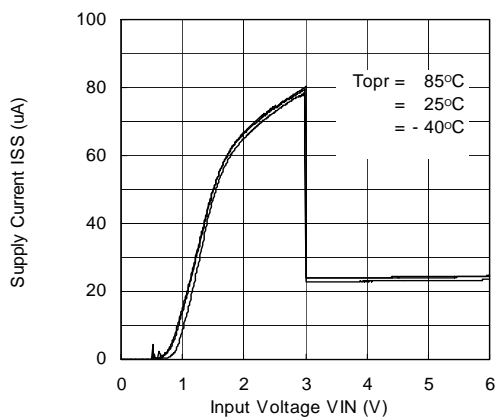
XC6401(0.8V)



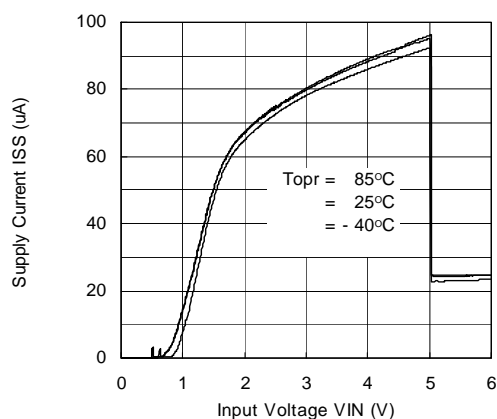
XC6401(2.85V)



XC6401(3.0V)

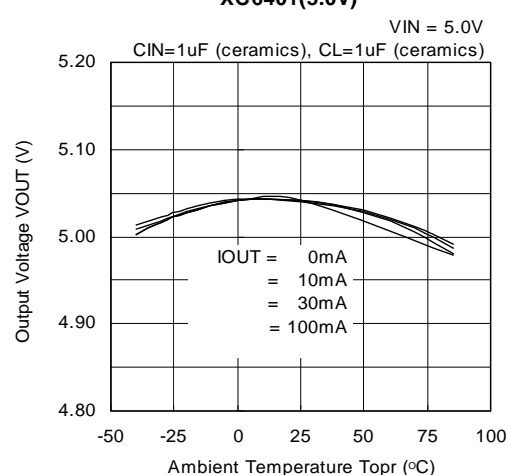
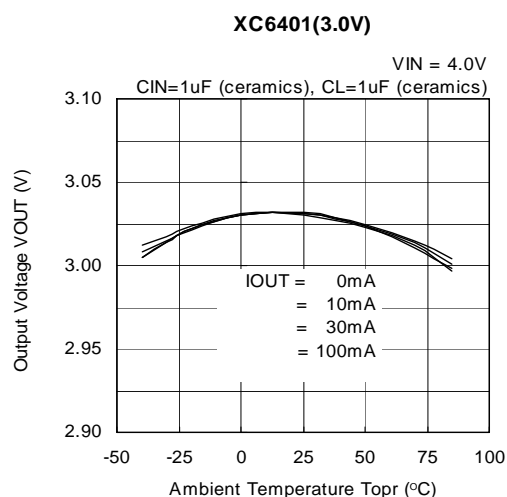
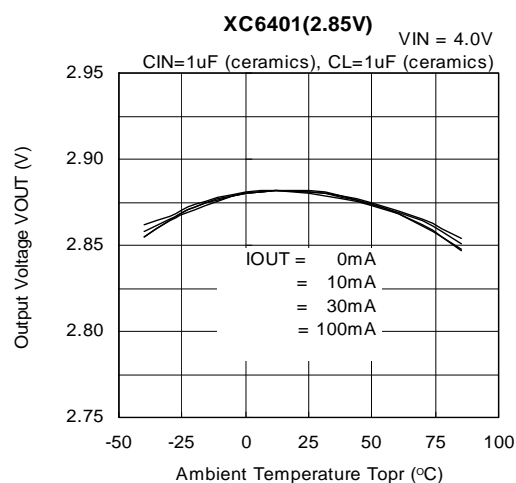
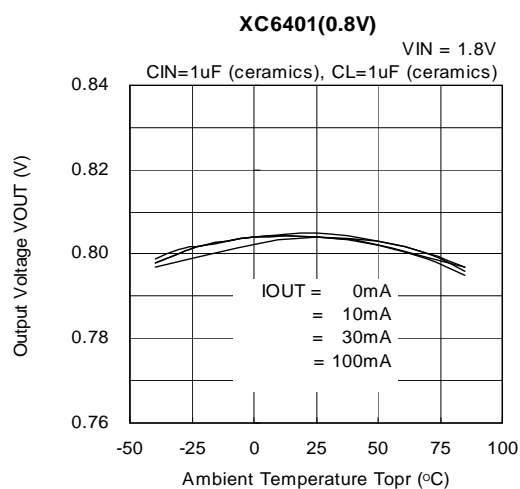


XC6401(5.0V)

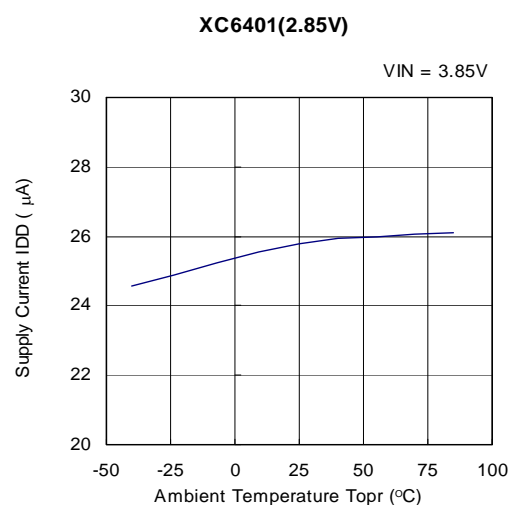
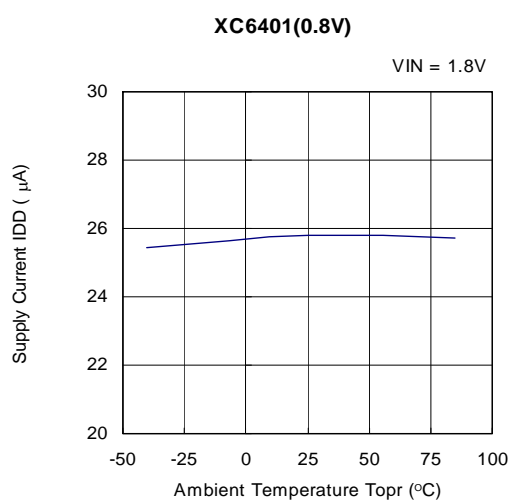


■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(5) Output Voltage vs. Ambient Temperature

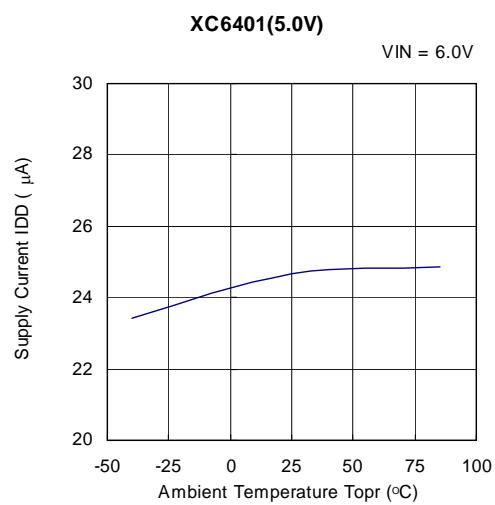
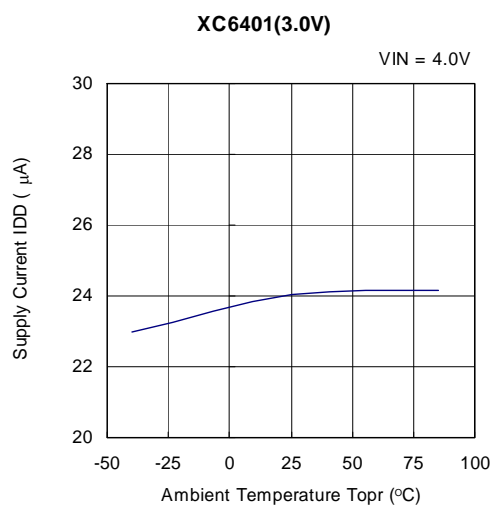


(6) Supply Current vs. Ambient Temperature



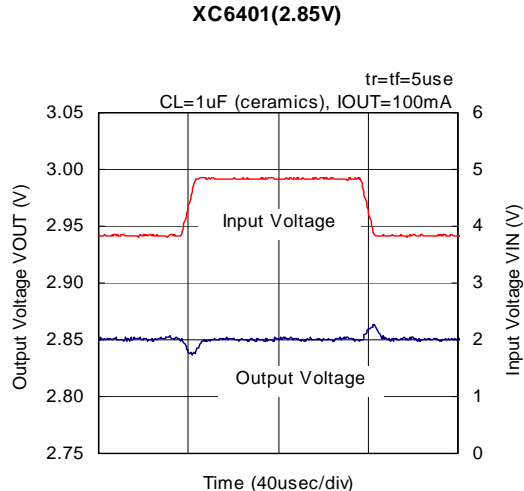
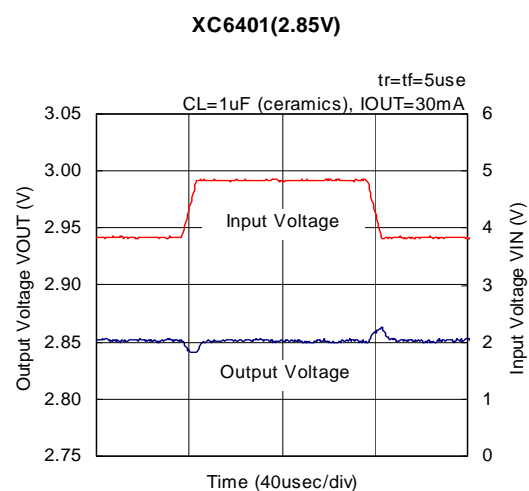
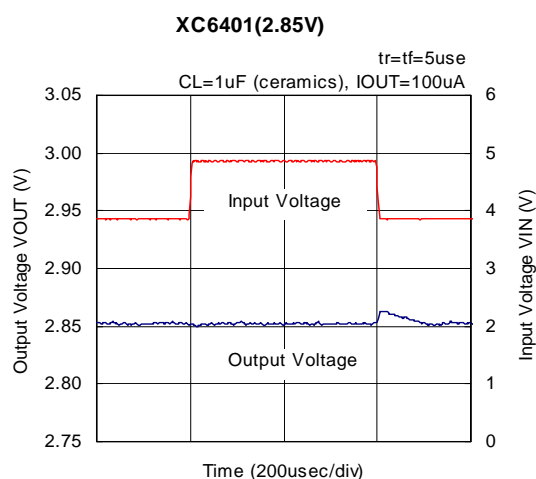
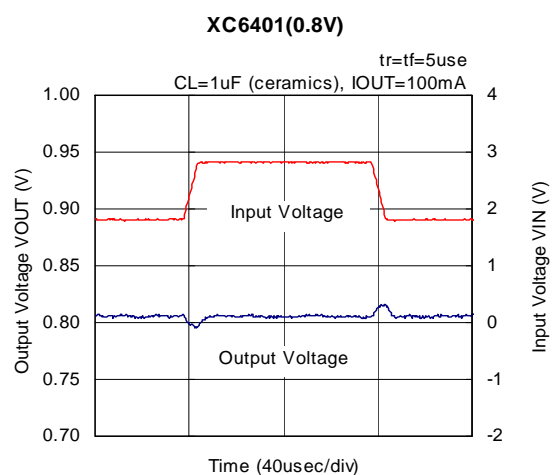
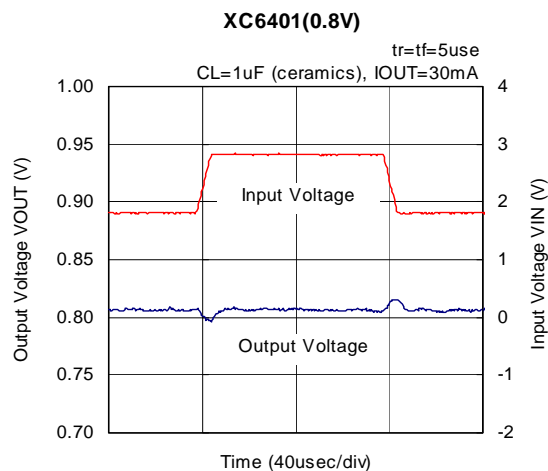
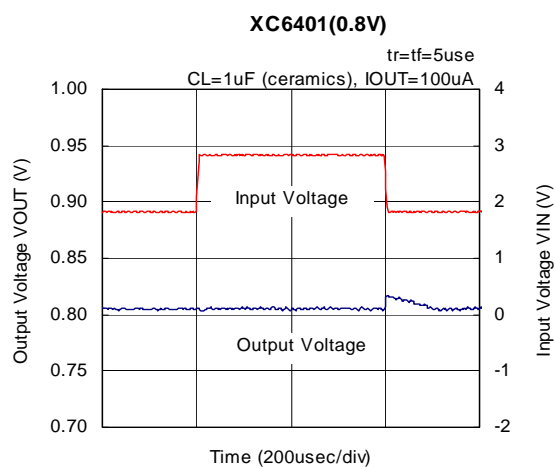
■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(6) Supply Current vs. Ambient Temperature (Continued)



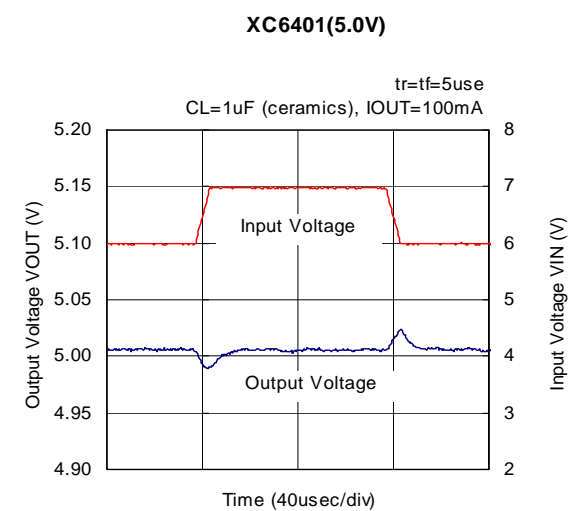
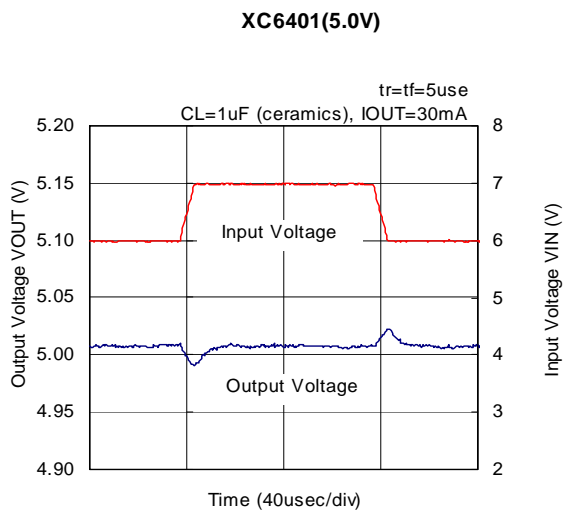
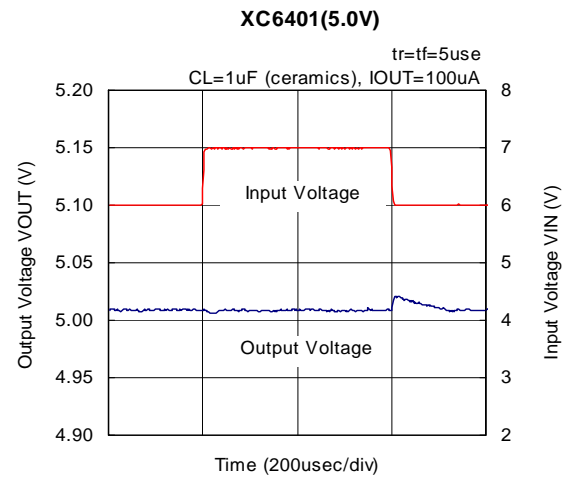
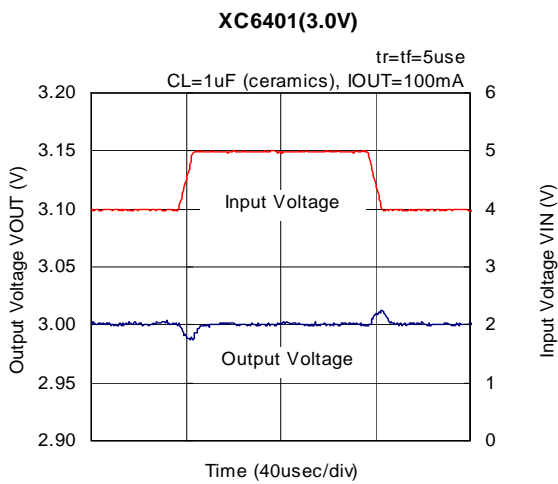
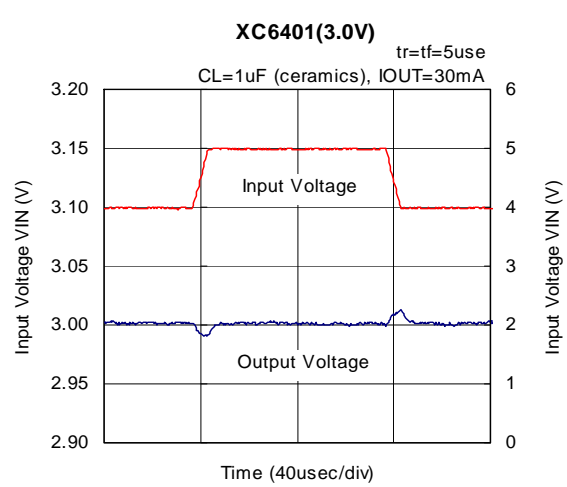
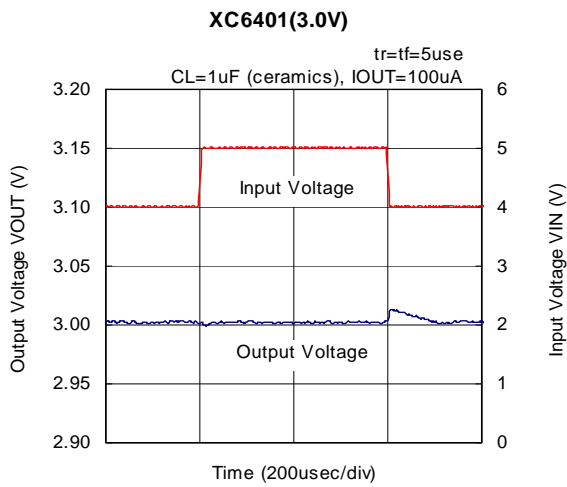
■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(7) Input Transient Response



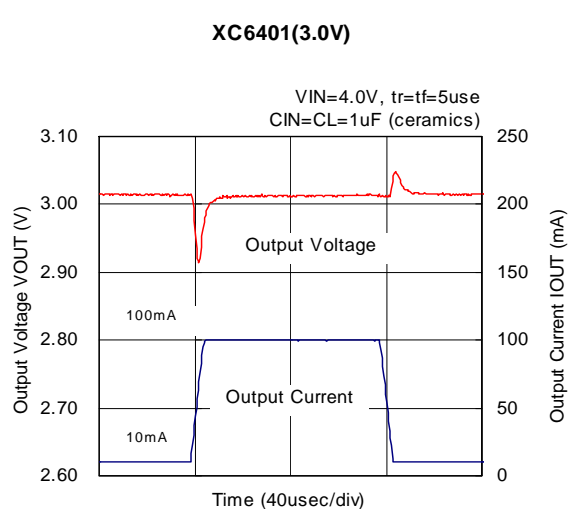
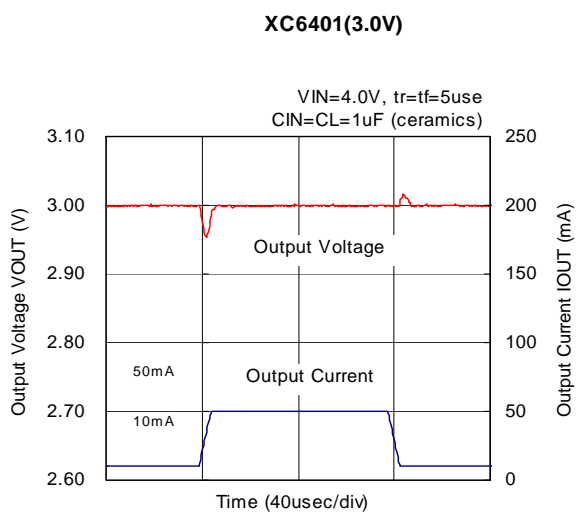
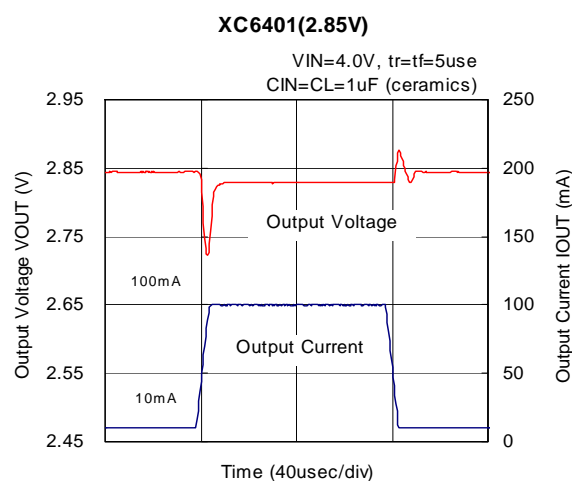
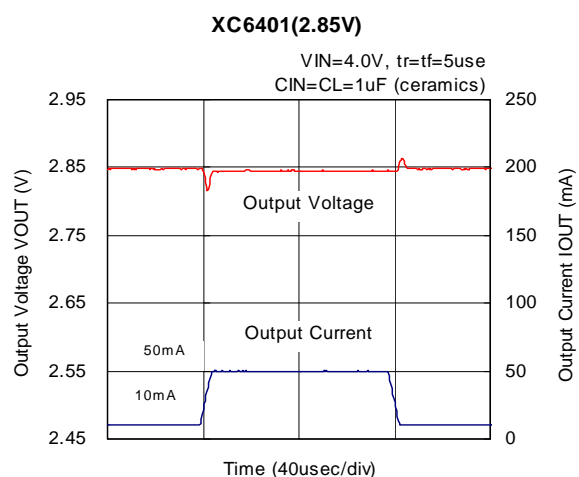
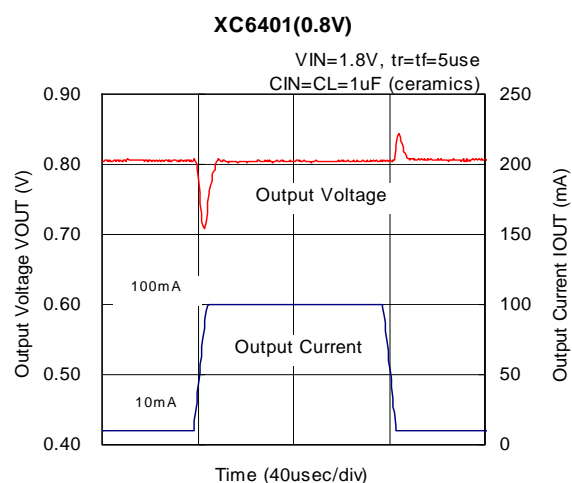
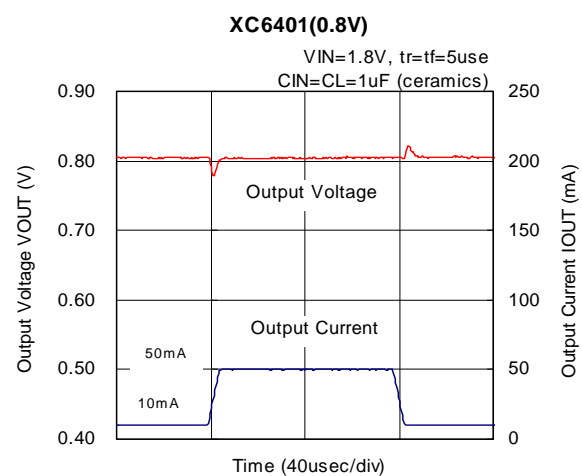
■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(7) Input Transient Response (Continued)



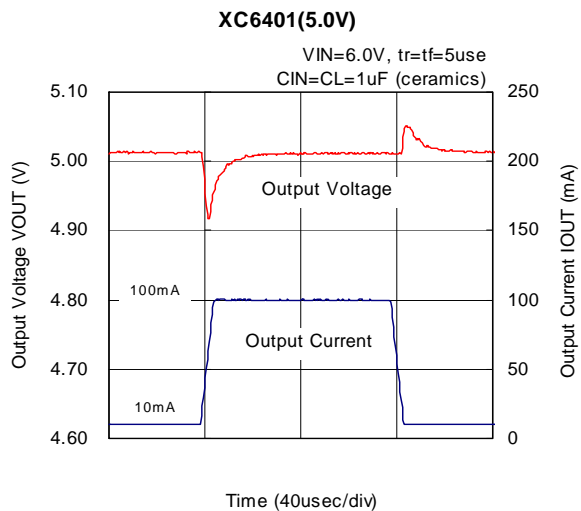
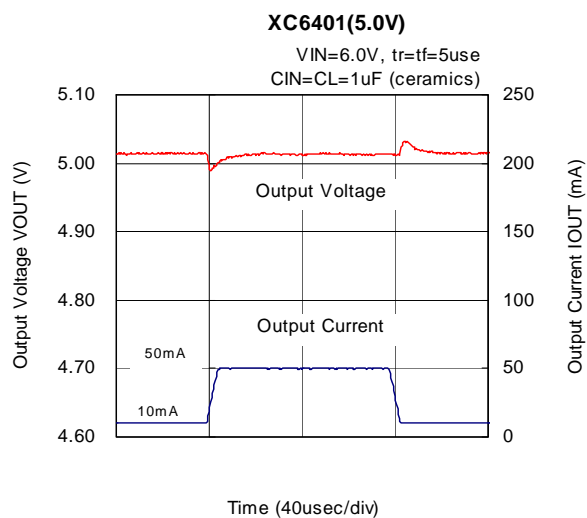
■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(8) Load Transient Response



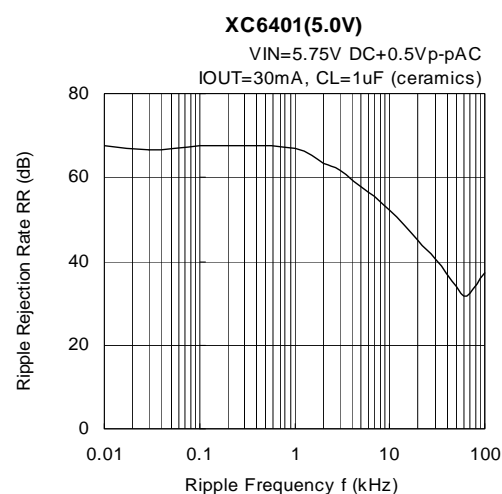
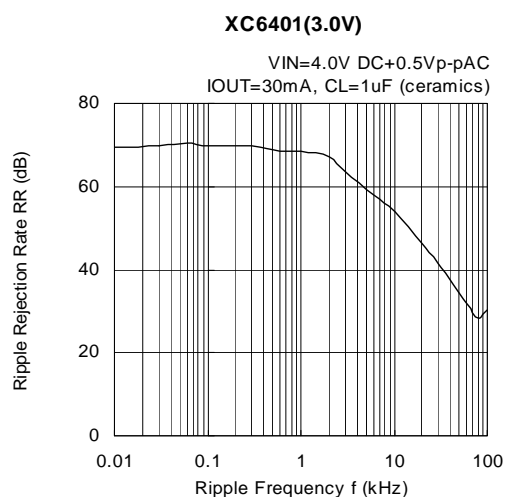
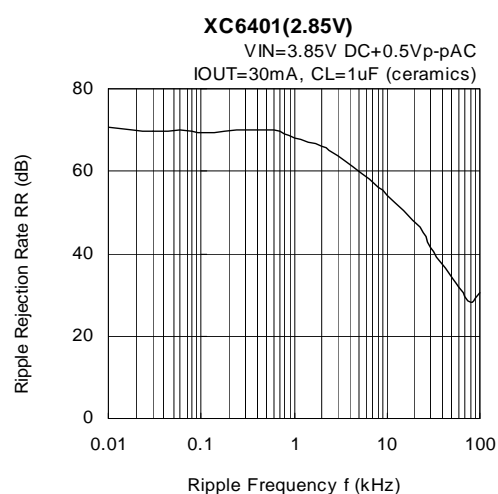
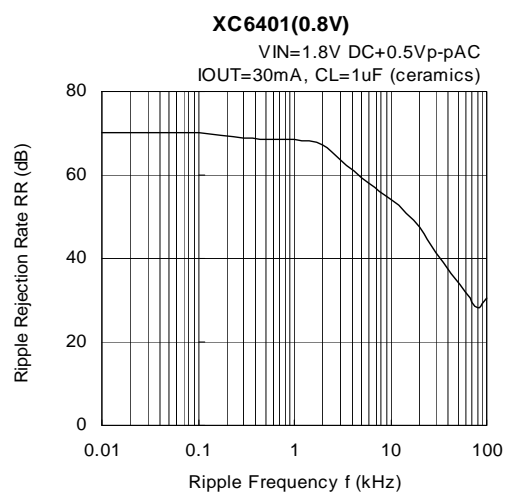
■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(8) Load Transient Response (Continued)

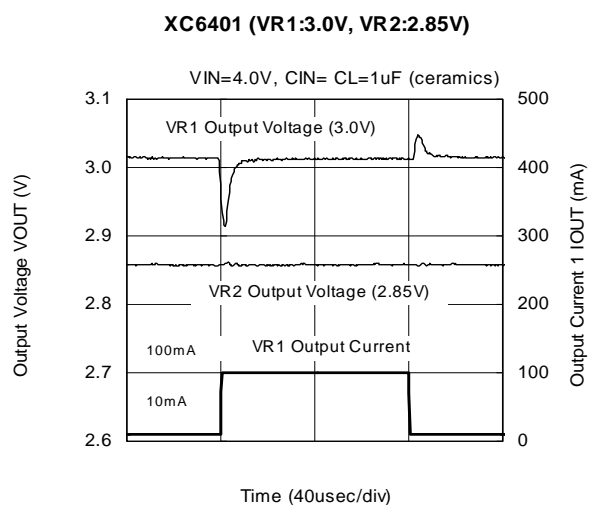


■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(9) Ripple Rejection Rate

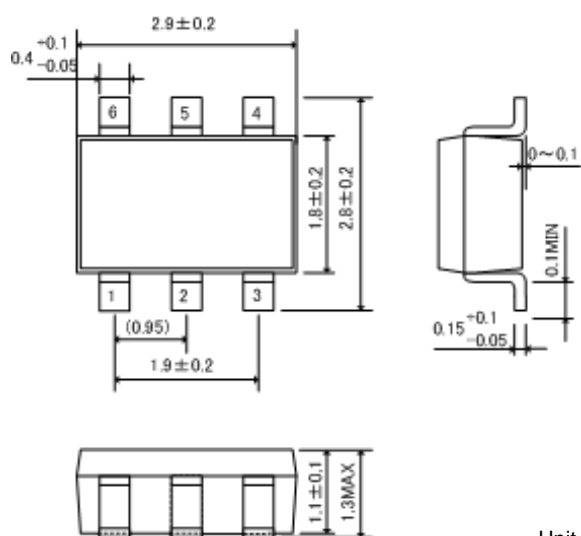


(10) Cross Talk



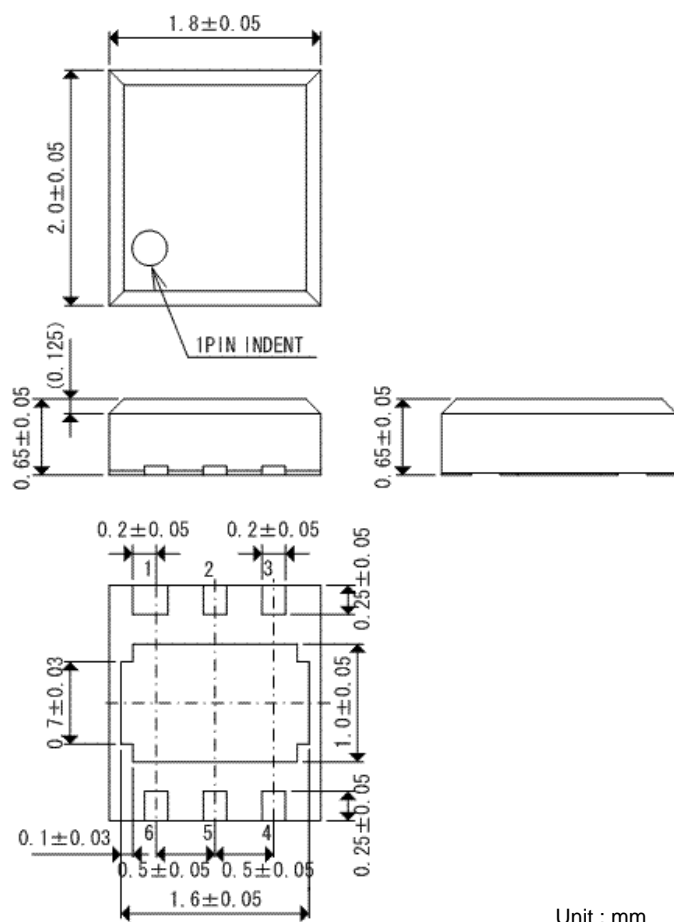
PACKAGING INFORMATION

● SOT-26W



Unit : mm

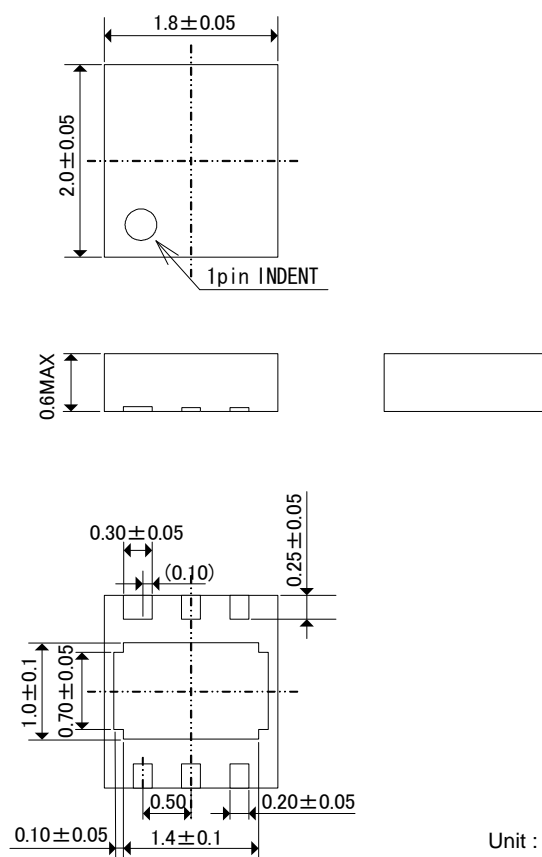
● USP-6B



Unit : mm

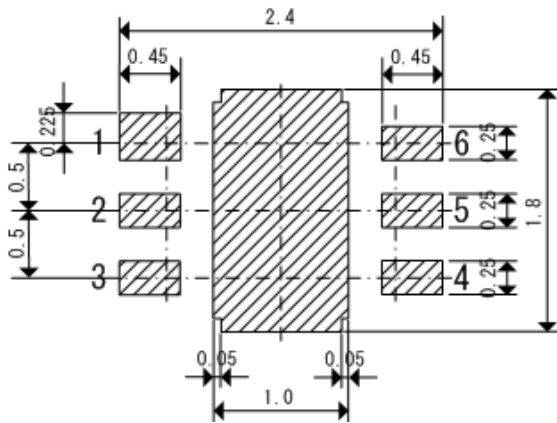
■ PACKAGING INFORMATION (Continued)

● USP-6C

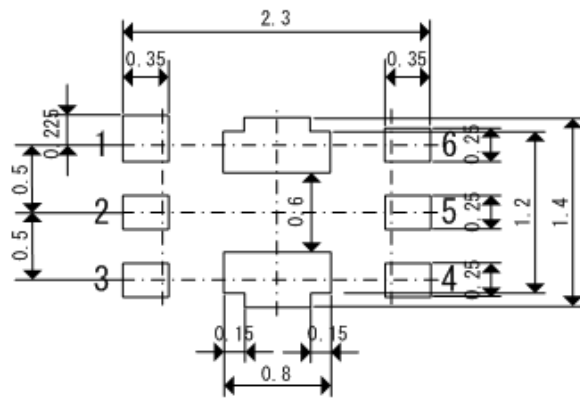


■ PACKAGING INFORMATION (Continued)

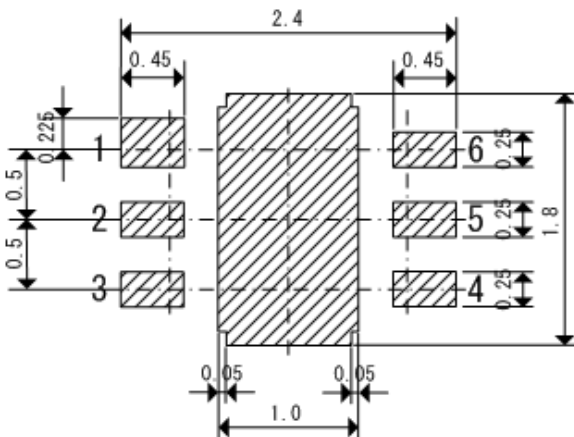
● USP-6B Reference Pattern Layout



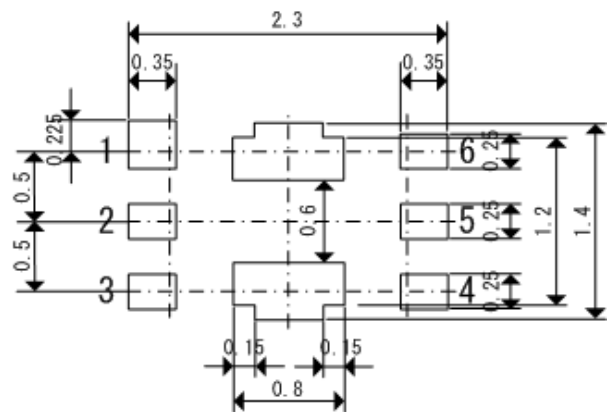
● USP-6B Reference Metal Mask Design



● USP-6C Reference Pattern Layout

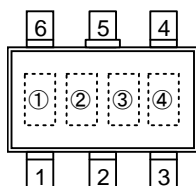


● USP-6C Reference Metal Mask Design



MARKING RULE

●SOT-26W



SOT-26W
(TOP VIEW)

① represents product series

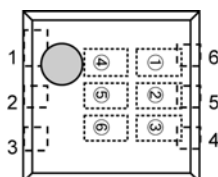
MARK	PRODUCT SERIES
1	XC6401xxxxMx

②③ represents internally set sequential number
ex.)

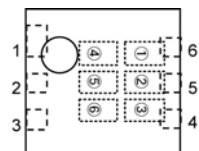
MARK		INTERNALLY SET SEQUENTIAL NUMBER	PRODUCT SERIES
②	③		
C	2	C2	XC6401EED5
C	0	C0	XC6401EED6
0	1	01	XC6401FF36
1	8	18	XC6401FF37

④ represents production lot number
0 to 9, A to Z reverse character 0 to 9, A to A repeated (G, I, J, O, Q, W excluded).

●USP-6B,USP-6C



USP-6B
(TOP VIEW)



USP-6C
(TOP VIEW)

① represents product series

MARK	PRODUCT SERIES
1	XC6401xxxxxx

② represents type of VR1 regulator

MARK	OPTIONAL FUNCTIONS	PRODUCT SERIES
E	EN1: High Active with pull-down resistor	XC6401Exxxxx
F	EN1: High Active with no pull-down resistor	XC6401Fxxxxx
Z	EN1: Low Active with pull-up resistor	XC6401Gxxxxx
H	EN1: Low Active with no pull-up resistor	XC6401Hxxxxx

③ represents type of VR2 regulator

MARK	OPTIONAL FUNCTIONS	PRODUCT SERIES
E	EN1: High Active with pull-down resistor	XC6401xExxxx
F	EN1: High Active with no pull-down resistor	XC6401xFxxxx
Z	EN1: Low Active with pull-up resistor	XC6401xGxxxx
H	EN1: Low Active with no pull-up resistor	XC6401xHxxxx

④⑤ represents VR output voltage (serial number ex.)

MARK		OUTPUT VOLTAGE		PRODUCT SERIES
④	⑤	VR1 (V)	VR2 (V)	
0	1	2.85	2.10	XC6401xx01xx
0	2	2.85	2.85	XC6401xx02xx

⑥ represents production lot number
0 to 9, A to Z repeated (G, I, J, O, Q, W excluded)
Note: No character inversion used

1. The products and product specifications contained herein are subject to change without notice to improve performance characteristics. Consult us, or our representatives before use, to confirm that the information in this datasheet is up to date.
2. We assume no responsibility for any infringement of patents, patent rights, or other rights arising from the use of any information and circuitry in this datasheet.
3. Please ensure suitable shipping controls (including fail-safe designs and aging protection) are in force for equipment employing products listed in this datasheet.
4. The products in this datasheet are not developed, designed, or approved for use with such equipment whose failure or malfunction can be reasonably expected to directly endanger the life of, or cause significant injury to, the user.
(e.g. Atomic energy; aerospace; transport; combustion and associated safety equipment thereof.)
5. Please use the products listed in this datasheet within the specified ranges.
Should you wish to use the products under conditions exceeding the specifications, please consult us or our representatives.
6. We assume no responsibility for damage or loss due to abnormal use.
7. All rights reserved. No part of this datasheet may be copied or reproduced without the prior permission of TOREX SEMICONDUCTOR LTD.

TOREX SEMICONDUCTOR LTD.